

N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Biju Chandran et al.

Examiner: Vigushin, John

Patent No.: 7,235,886

Group Art Unit: 2841

Issue Date: June 26, 2007

Docket No; 884.A27US1

Title: CHIP-JOIN PROCESS TO REDUCE ELONGATION MISMATCH BETWEEN THE ADHERENTS

AND SEMICONDUCTOR PACKAGE MADE THEREBY

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

ATTN: CERTIFICATE OF CORRECTION BRANCH

We are transmitting herewith the attached:

X Request for Certificate of Correction.

X Certificate of Correction Form - PTO-1050 (in duplicate)

X A return postcard.

Certificate
of Correction

Please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer No: 21186

Name: Lucinda G. Price

Reg. No.42,270 LGP:CMG:raq

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents and Trademarks, P.O. Box 1450, Alexandria VA 22313-1450, on this 4 day of August 2007.

Chris Hommand

Name

Signature



PATENT

IN UNITED STATES PATENT AND TRADEMARK OFFICE

Patent No.:

7,235,886

Docket No: 884.A27US1

Issue Date:

June 26, 2007

Patentee: Biju Chandran et al.

Customer No.: 21186

Confirmation No.: 3133

Title

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REQUEST FOR CERTIFICATE OF CORRECTION

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

ATTN: CERTIFICATE OF CORRECTION BRANCH

It is requested that a Certificate of Correction be issued correcting printing errors appearing in the above-identified United States patent. Two copies of the text of the Certificate in the suggested form are enclosed.

Issuance of the Certificate of Correction would neither expand nor contract the scope of the claims as properly allowed, and re-examination is not required.

As the error is that of the Patent Office, it is believed that no fee is due.

The Examiner is authorized to charge any additional fees or credit overpayment to Deposit Account No.19-0743.

Respectfully Submitted

BIJU CHANDRAN ET AL.

By their Representatives,

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LGP:raq

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UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO

: 7,235,886

Page (1) of 1

DATED

: June 26, 2007

INVENTOR(S)

: Chandran et al.

It is certified that errors appear in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the face page, in field (56), under "Other Publications", in column 2, line 4, delete "TD-291011" and insert - - RD-291011 - -, therefor.

On the face page, in field (57), under "Absract", in column 2, line 11, delete "up" and insert - - upon - -, therefor.

In column 6, line 17, in Claim 3, delete "clam 1" and insert - - claim 1 - -, therefor.

In column 6, line 43, in Claim 7, after "at a" delete "the".

In column 6, line 67, in Claim 12, delete "heat" and insert - - heating - -, therefor.

In column 7, line 39, in Claim 17, delete "jointed" and insert - - joined - -, therefor.

In column 7, lines 45-46, in Claim 18, after "solder joint." delete "onto a surface of the substrate to form the soldered joint.". (Second Occurrence)

In column 7, line 56 (Approx.), in Claim 19, before "soldered" insert - - of - -.

In column 8, line 24 (Approx.), in Claim 22, after "and" insert - - the - -.

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PATENT NO. _____ 7,235,886

SCHWEGMAN, LUNDBERG, WOESSNER, & KLUTH, P.A. P.O. BOX 2938 Minneapolis, MN 55402

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UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

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